Light is OSRAM



15.10.2020

OS-IN-2020-030 Update of solder pad drawing for OBF-S family

Objective	Update of solder pad drawing of OBF-S family	
Products affected	KW HJL531.TE, KW HKL531.TE, KW HLL531.TE and KW2 HIL531.TE	
Background	Updated solder pad design to improve and stabilize the soldering process	
Realization	Following drawings are updated: →optimized solder mask design Please refer to 2_CIP_OS-IN-2020-030 for details	
Time Schedule	Updated datasheets are available.	
Assessment	No change in fit, form, function and reliability.	

Please direct your inquiry to your local Sales office.

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OS-IN-2020-030 Update of solder pad drawing of OBF-S family

Customer information package

OS QM CQM A | 15.10.2020





OS-IN-2020-030 Update of solder pad drawing of OBF-S family



Up-dated solder pad drawings

Sub brand	Туре	Solder pad drawing # current
OSLON Black Flat S 2-Chip	KW2 HIL532.TK	E062.3010.267-02
OSLON Black Flat S 3-Chip	KW HJL531.TE	E062.3010.203-02
OSLON Black Flat S 4-Chip	KW HKL531.TE	E062.3010.215-01
OSLON Black Flat S 5-Chip	KW HLL531.TE	E062.3010.214-02

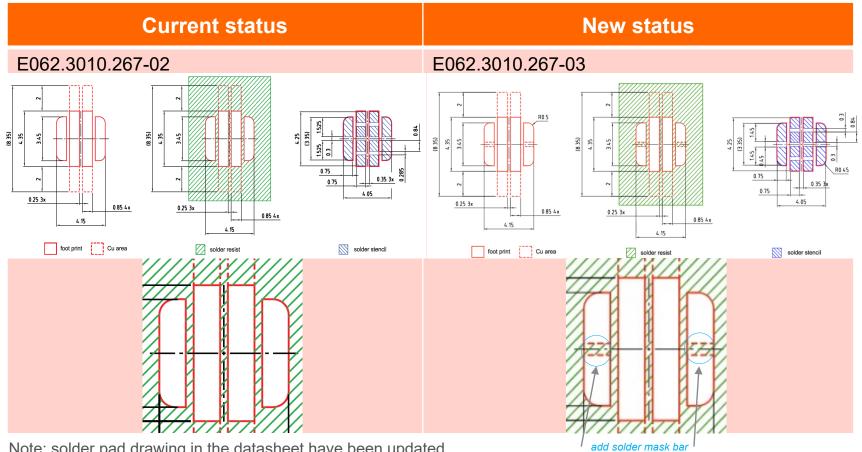
For additional information regarding the most important changes please refer to the next pages Note: Latest version of data sheet is accessible on OSRAM OS homepage



OS-IN-2020-030 Update of solder pad drawing of OBF-S family



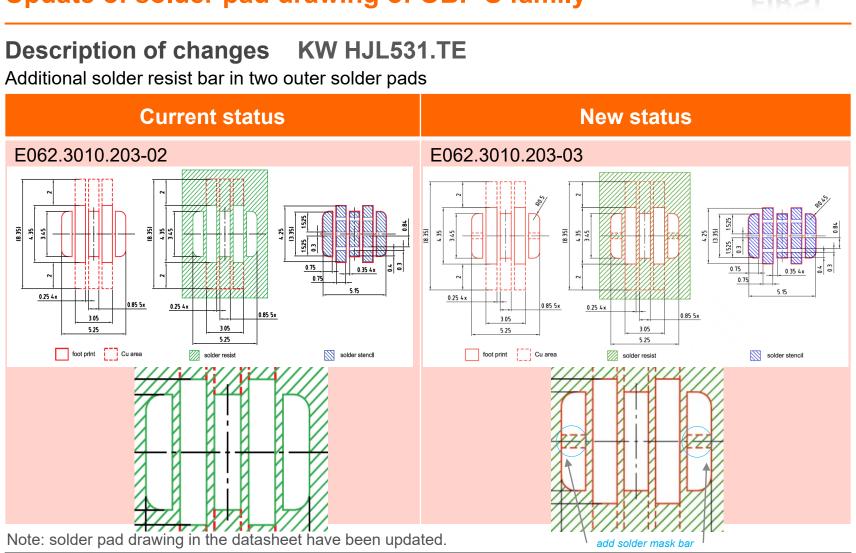
Additional solder resist bar in two outer solder pads



Note: solder pad drawing in the datasheet have been updated.

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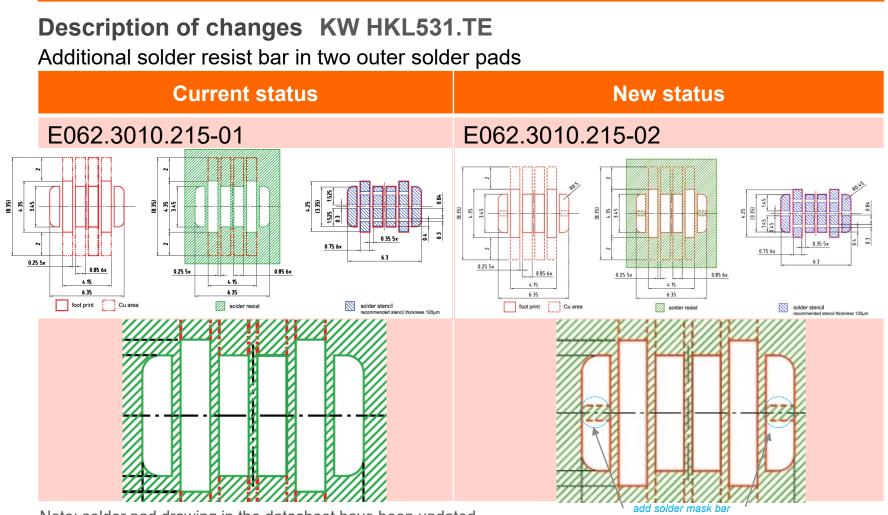
Update of solder pad drawing of OBF-S family

OS-IN-2020-030

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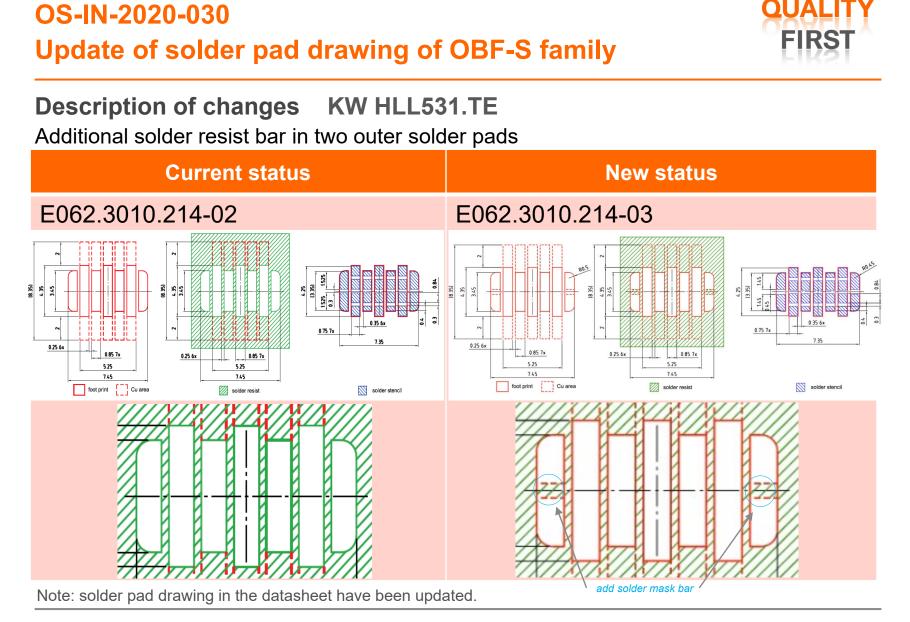


Update of solder pad drawing of OBF-S family

Note: solder pad drawing in the datasheet have been updated.

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Thank you.

